TOSHIBA

MICROWAVE POWER GaAs FET

TIM1414-8L

Low Distortion Internally Matched Power GaAs FETs (X, Ku-Band)

Features

- Low intermodulation distortion
 - $IM_3 = -45 \text{ dBc at Po} = 28 \text{ dBm}$,
 - Single carrier level
- High power
 - $P_{1dB} = 39.5 \text{ dBm}$ at 14.0 GHz to 14.5 GHz
- High gain
 - $G_{1dB} = 5.0 \text{ dB}$ at 14.0 GHz to 14.5 GHz
- · Broad band internally matched
- Hermetically sealed package

RF Performance Specifications (Ta = 25° C)

Characteristics	Symbol	Condition	Unit	Min.	Тур.	Max
Output Power at 1dB Compression Point	P _{1dB}		dBm	38.5	39.5	-
Power Gain at 1dB Compression Point	G _{1dB}	V _{DS} = 9V	dB	4.0	5.0	_
Drain Current	I _{DS1}	f = 14.0 ~ 14.5 GHz	Α	_	3.4	4.4
Gain Flatness	ΔG		dB	_	_	±0.8
Power Added Efficiency	η _{add}	DataSheet4U.co	^m %	_	20	-
3rd Order Intermodulation Distortion	IM ₃	Note 1	dBc	-42	-45	_
Drain Current	I _{DS2}	14016 1	А	_	3.4	4.4
Channel-Temperature Rise	ΔT _{ch}	$V_{DS}xI_{DS}xR_{th(c-c)}$	°C	_	_	80

Note 1: 2 Tone Test (Pout = 28 dBm Single Carrier Level).

Electrical Characteristics (Ta = 25° C)

Characteristic	Symbol	Condition	Unit	Min.	Тур.	Max
Trans-conductance	gm	$V_{DS} = 3V$ $I_{DS} = 4.0A$	mS	_	2400	_
Pinch-off Voltage	V _{GSoff}	$V_{DS} = 3V$ $I_{DS} = 120 \text{mA}$	V	-2	-3.5	-5
Saturated Drain Current	I _{DSS}	$V_{DS} = 3V$ $V_{GS} = 0V$	А	_	8.0	10.4
Gate-Source Breakdown Voltage	V_{GSO}	I _{GS} = -120μA	V	-5	_	_
Thermal Resistance	R _{th (c-c)}	Channel to case	°C/W	_	1.6	2.5

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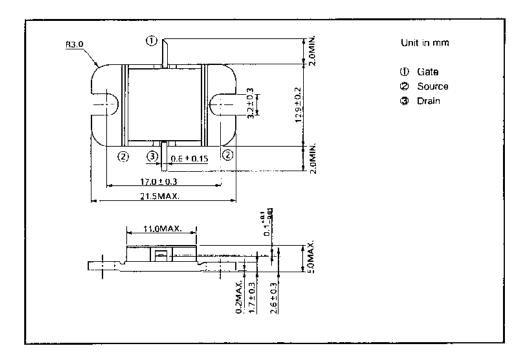
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Absolute Maximum Ratings (Ta = 25° C)

Characteristic	Symbol	Unit	Rating
Drain-Source Voltage	V _{DS}	V	15
Gate-Source Voltage	V _{GS}	V	-5
Drain Current	I _{DS}	А	10.4
Total Power Dissipation (T _c = 25°C)	P _T	W	60
Channel Temperature	T _{ch}	°C	175
Storage Temperature	T _{stg}	°C	-65~175

Package Outline (2-11C1B)



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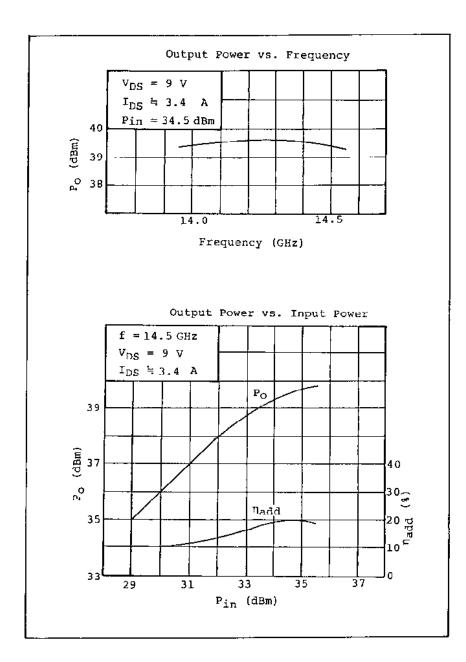
Handling Precautions for Packaged Type

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Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

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RF Performances



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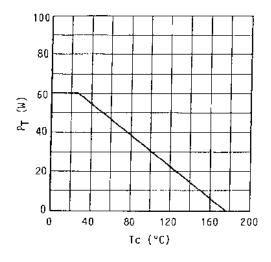
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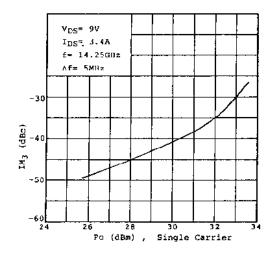
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Power Dissipation vs. Case Temperature



IM₃ vs. Output Power Characteristics

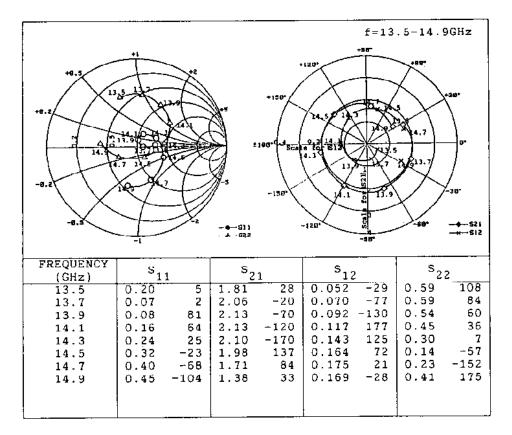
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TIM1414-8L S-Parameters (MAGN. and ANGLES)



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